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DATA SHEET

74LV251

8-input multiplexer (3-State)

Philips
Semiconductors

PHILIPS

8-input multiplexer (3-State)   74LV251

FEATURES

- Optimized for low voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between V_{CC} = 2.7 V and V_{CC} = 3.6 V
- Typical V_{OLP} (output ground bounce) < 0.8 V at V_{CC} = 3.3 V, T_{amb} = 25°C
- Typical V_{OHV} (output V_{OH} undershoot) > 2 V at V_{CC} = 3.3 V, T_{amb} = 25°C
- True and complement outputs
- Both outputs are 3-State for further multiplexer expansion
- Multifunction capability
- Permits multiplexing from n-lines to one line
- Output capability: standard
- I_{CC} category: MSI

DESCRIPTION

The 74LV251 is a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC/HCT251.

The 74LV251 is an 8-input multiplexer with 8 binary inputs (I_0 to I_7), an output enable input ($\overline{OE}$) and three select inputs (S_0, S_1, S_2). One of the eight binary inputs is selected by the select inputs and is routed to the outputs ($\overline{Y}$, Y). Both outputs are in the high impedance OFF-state (Z) when the output enable input is HIGH, allowing multiplexer expansion by tying the outputs.

QUICK REFERENCE DATA

GND = 0 V; T_{amb} = 25°C; t_r = t_f ≤ 2.5 ns

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t_{PHL}/t_{PLH}	Propagation delay I_n to Y I_n to $\overline{Y}$ S_n to Y S_n to $\overline{Y}$	C_L = 15 pF; V_{CC} = 3.3 V	14 16 19 20	ns
C_I	Input capacitance		3.5	pF
C_{PD}	Power dissipation capacitance per gate	V_{CC} = 3.3 V V_I = GND to V_{CC}[1]	44	pF

NOTE:

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW)
   $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:
   f_i = input frequency in MHz; C_L = output load capacitance in pF;
   f_o = output frequency in MHz; V_{CC} = supply voltage in V;
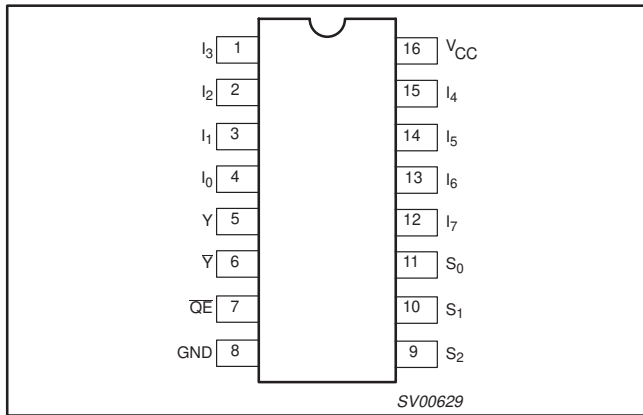 $\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
16-Pin Plastic DIL	−40°C to +125°C	74LV251 N	74LV251 N	SOT38-4
16-Pin Plastic SO	−40°C to +125°C	74LV251 D	74LV251 D	SOT109-1
16-Pin Plastic SSOP Type II	−40°C to +125°C	74LV251 DB	74LV251 DB	SOT338-1
16-Pin Plastic TSSOP Type I	−40°C to +125°C	74LV251 PW	74LV251PW DH	SOT403-1

8-input multiplexer (3-State)

PIN CONFIGURATION
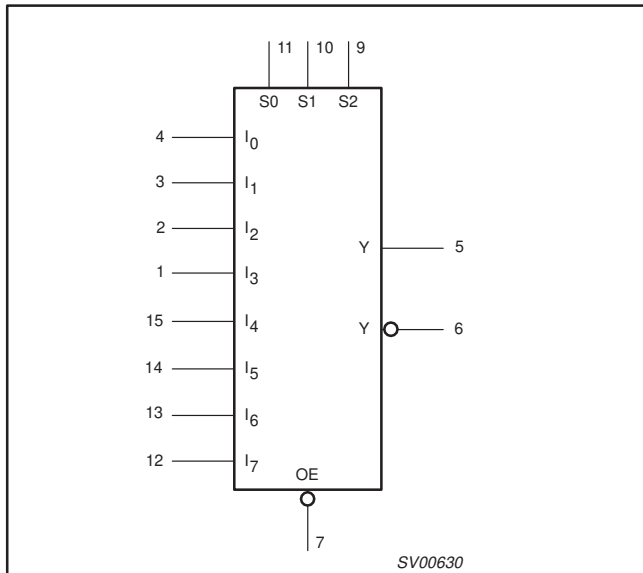
I_3	1		16	V_{CC}
I_2	2		15	I_4
I_1	3		14	I_5
I_0	4		13	I_6
Y	5		12	I_7
$\overline{Y}$	6		11	S_0
$\overline{QE}$	7		10	S_1
GND	8		9	S_2

SV00629

PIN DESCRIPTION

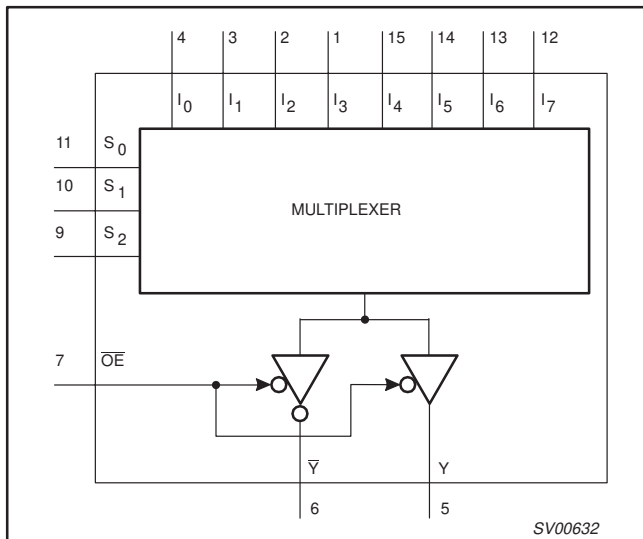| PIN NUMBER	SYMBOL	FUNCTION
4, 3, 2, 1, 15, 14, 13, 12	I_0 to I_7	Multiplexer inputs
5	Y	Multiplexer output
6	$\overline{Y}$	Complementary multiplexer output
7	$\overline{OE}$	3-State output enable input (active LOW)
8	GND	Ground (0 V)
11, 10, 9	S_0 to S_2	Select inputs
16	V_{CC}	Positive supply voltage

LOGIC SYMBOL

SV00630

LOGIC SYMBOL (IEEE/IEC)

SV00631
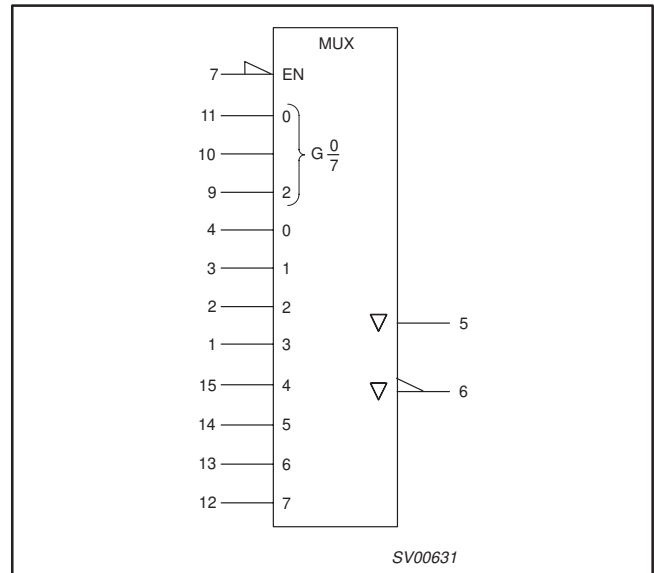
FUNCTIONAL DIAGRAM

SV00632

8-input multiplexer (3-State)

74LV251

FUNCTION TABLE

INPUTS												OUTPUTS	
$\overline{OE}$	S_2	S_1	S_0	I_0	I_1	I_2	I_3	I_4	I_5	I_6	I_7	$\overline{Y}$	Y
H	X	X	X	X	X	X	X	X	X	X	X	Z	Z
L	L	L	L	L	X	X	X	X	X	X	X	H	L
L	L	L	L	H	X	X	X	X	X	X	X	L	H
L	L	L	H	X	L	X	X	X	X	X	X	H	L
L	L	L	H	X	H	X	X	X	X	X	X	L	H
L	L	H	L	X	X	L	X	X	X	X	X	H	L
L	L	H	L	X	X	H	X	X	X	X	X	L	H
L	L	H	H	X	X	X	L	X	X	X	X	H	L
L	L	H	H	X	X	X	H	X	X	X	X	L	H
L	H	L	L	X	X	X	X	L	X	X	X	H	L
L	H	L	L	X	X	X	X	H	X	X	X	L	H
L	H	L	H	X	X	X	X	X	L	X	X	H	L
L	H	L	H	X	X	X	X	X	H	X	X	L	H
L	H	H	L	X	X	X	X	X	X	L	X	H	L
L	H	H	L	X	X	X	X	X	X	H	X	L	H
L	H	H	H	X	X	X	X	X	X	X	L	H	L
L	H	H	H	X	X	X	X	X	X	X	H	L	H

NOTES:
H = HIGH voltage level
L = LOW voltage level
X = don't care
Z = high impedance OFF-state

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
V_{CC}	DC supply voltage	See Note 1	1.0	3.3	3.6	V
V_I	Input voltage		0	–	V_{CC}	V
V_O	Output voltage		0	–	V_{CC}	V
T_{amb}	Operating ambient temperature range in free air	See DC and AC characteristics	−40 −40		+85 +125	°C
t_r, t_f	Input rise and fall times	V_{CC} = 1.0V to 2.0V V_{CC} = 2.0V to 2.7V V_{CC} = 2.7V to 3.6V	– – –	– – –	500 200 100	ns/V

NOTE:
1. The LV is guaranteed to function down to V_{CC} = 1.0V (input levels GND or V_{CC}); DC characteristics are guaranteed from V_{CC} = 1.2V to V_{CC} = 5.5V.

8-input multiplexer (3-State)

ABSOLUTE MAXIMUM RATINGS[1, 2]

In accordance with the Absolute Maximum Rating System (IEC 134).
Voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V_{CC}	DC supply voltage		−0.5 to +4.6	V
± I_{IK}	DC input diode current	$V_I < −0.5$ or $V_I > V_{CC} + 0.5V$	20	mA
± I_{OK}	DC output diode current	$V_O < −0.5$ or $V_O > V_{CC} + 0.5V$	50	mA
± I_O	DC output source or sink current – standard outputs	$−0.5V < V_O < V_{CC} + 0.5V$	25	mA
± I_{GND}, ± I_{CC}	DC V_{CC} or GND current for types with – standard outputs		50	mA
T_{stg}	Storage temperature range		−65 to +150	°C
P_{TOT}	Power dissipation per package – plastic DIL – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: −40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

NOTES:
1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS					UNIT
			-40°C to +85°C			-40°C to +125°C		
			MIN	TYP[1]	MAX	MIN	MAX	
V_{IH}	HIGH level Input voltage	V_{CC} = 1.2 V	0.9			0.9		V
		V_{CC} = 2.0 V	1.4			1.4		
		V_{CC} = 2.7 to 3.6 V	2.0			2.0		
V_{IL}	LOW level Input voltage	V_{CC} = 1.2 V			0.3		0.3	V
		V_{CC} = 2.0 V			0.6		0.6	
		V_{CC} = 2.7 to 3.6 V			0.8		0.8	
V_{OH}	HIGH level output voltage; all outputs	V_{CC} = 1.2 V; $V_I = V_{IH}$ or V_{IL}; $−I_O = 100\mu A$		1.2				V
		V_{CC} = 2.0 V; $V_I = V_{IH}$ or V_{IL}; $−I_O = 100\mu A$	1.8	2.0		1.8		
		V_{CC} = 2.7 V; $V_I = V_{IH}$ or V_{IL}; $−I_O = 100\mu A$	2.5	2.7		2.5		
		V_{CC} = 3.0 V; $V_I = V_{IH}$ or V_{IL}; $−I_O = 100\mu A$	2.8	3.0		2.8		
V_{OH}	HIGH level output voltage; STANDARD outputs	V_{CC} = 3.0 V; $V_I = V_{IH}$ or V_{IL}; $−I_O = 6mA$	2.40	2.82		2.20		V
V_{OL}	LOW level output voltage; all outputs	V_{CC} = 1.2 V; $V_I = V_{IH}$ or V_{IL}; $I_O = 100\mu A$		0				V
		V_{CC} = 2.0 V; $V_I = V_{IH}$ or V_{IL}; $I_O = 100\mu A$		0	0.2		0.2	
		V_{CC} = 2.7 V; $V_I = V_{IH}$ or V_{IL}; $I_O = 100\mu A$		0	0.2		0.2	
		V_{CC} = 3.0 V; $V_I = V_{IH}$ or V_{IL}; $I_O = 100\mu A$		0	0.2		0.2	
V_{OL}	LOW level output voltage; STANDARD outputs	V_{CC} = 3.0 V; $V_I = V_{IH}$ or V_{IL}; $I_O = 6mA$		0.25	0.40		0.50	V

8-input multiplexer (3-State)

DC ELECTRICAL CHARACTERISTICS (Continued)

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS					UNIT
			-40°C to +85°C			-40°C to +125°C		
			MIN	TYP1	MAX	MIN	MAX	
I_I	Input leakage current	V_{CC} = 3.6 V; V_I = V_{CC} or GND			1.0		1.0	μA
I_{CC}	Quiescent supply current; MSI	V_{CC} = 3.6 V; V_I = V_{CC} or GND; I_O = 0			20.0		160	μA
ΔI_{CC}	Additional quiescent supply current per input	V_{CC} = 2.7 V to 3.6 V; V_I = V_{CC} − 0.6 V			500		850	μA

NOTE:
1. All typical values are measured at T_{amb} = 25°C.

AC CHARACTERISTICS
GND = 0V; t_r = t_f = 2.5ns; C_L = 50pF; R_L = 1KΩ

SYMBOL	PARAMETER	WAVEFORM	CONDITION	LIMITS					UNIT
				−40 to +85 °C			−40 to +125 °C		
			V_{CC}(V)	MIN	TYP1	MAX	MIN	MAX	
t_{PHL}/t_{PLH}	Propagation delay I_n to Y	Figure 1	1.2		90				ns
			2.0		31	58		70	
			2.7		23	43		51	
			3.0 to 3.6		17[2]	34		41	
t_{PHL}/t_{PLH}	Propagation delay I_n to $\overline{Y}$	Figure 2	1.2		100				ns
			2.0		34	65		77	
			2.7		25	48		56	
			3.0 to 3.6		19[2]	38		45	
t_{PHL}/t_{PLH}	Propagation delay S_n to Y	Figure 1	1.2		120				ns
			2.0		41	77		92	
			2.7		30	56		68	
			3.0 to 3.6		23[2]	45		54	
t_{PHL}/t_{PLH}	Propagation delay S_n to $\overline{Y}$	Figure 2	1.2		125				ns
			2.0		43	82		97	
			2.7		31	60		71	
			3.0 to 3.6		24[2]	48		57	
t_{PZH}/t_{PZL}	3-State output disable time $\overline{OE}$ to Y, $\overline{Y}$	Figure 2	1.2		65				ns
			2.0		22	43		51	
			2.7		16	31		38	
			3.0 to 3.6		12[2]	25		30	
t_{PHZ}/t_{PLZ}	3-State output disable time $\overline{OE}$ to Y, $\overline{Y}$	Figure 2	1.2		60				ns
			2.0		22	39		48	
			2.7		17	29		36	
			3.0 to 3.6		13[2]	24		29	

NOTES:
1. Unless otherwise stated, all typical values are measured at T_{amb} = 25°C
2. Typical values are measured at V_{CC} = 3.3 V.

8-input multiplexer (3-State)

AC WAVEFORMS

$V_M = 1.5$ V at $V_{CC} \geq 2.7$ V

$V_M = 0.5$ V $\times V_{CC}$ at $V_{CC} < 2.7$ V

V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.

$V_X = V_{OL} + 0.3$ V at $V_{CC} \geq 2.7$ V

$V_X = V_{OL} + 0.1 \times V_{CC}$ at $V_{CC} < 2.7$ V

$V_Y = V_{OH} - 0.3$ V at $V_{CC} \geq 2.7$V

$V_Y = V_{OH} - 0.1 \times V_{CC}$ at $V_{CC} < 2.7$ V
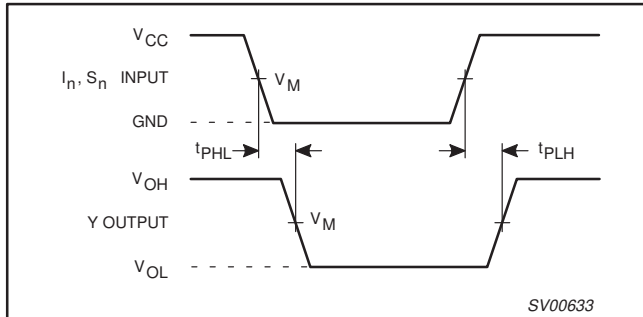
Figure 1. Multiplexer input (I_n) and select input (S_n) to output (Y) propagation delays.
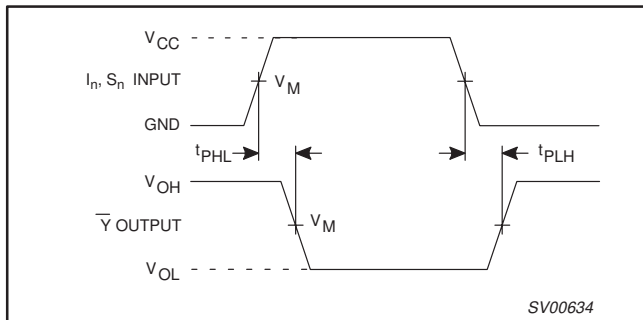

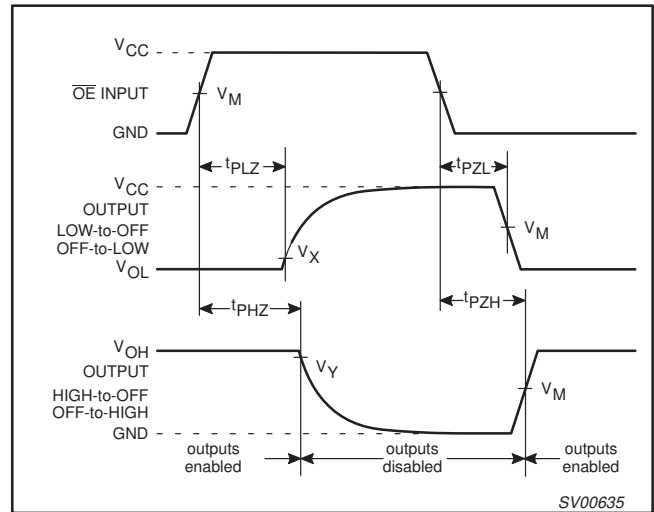Figure 2. Multiplexer input (I_n) and the select input (S_n) to output ($\overline{Y}$) propagation delays.

Figure 3. 3-State enable and disable times

TEST CIRCUIT

Test Circuit for switching times

DEFINITIONS

R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.

R_L = Load resistor

C_L = Load capacitance includes jig and probe capacitance

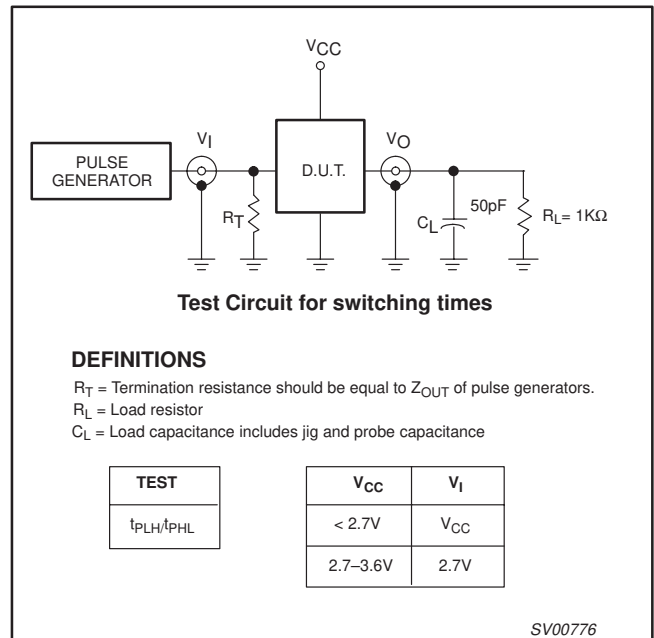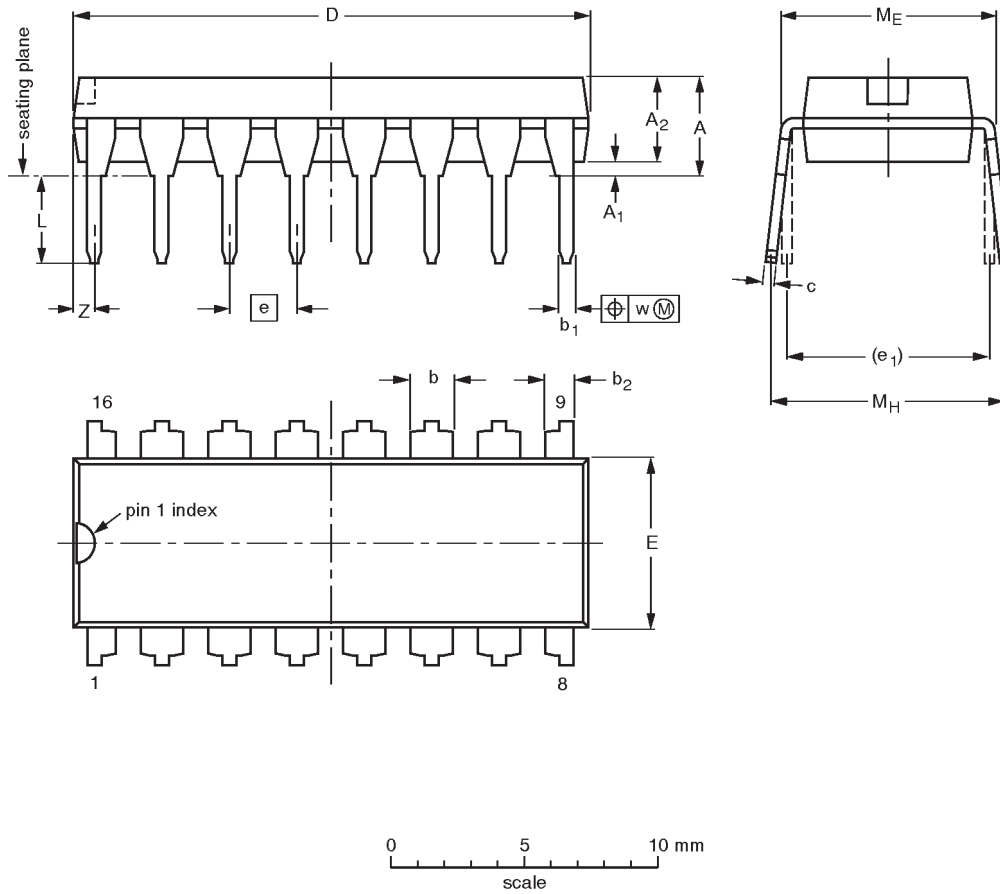| TEST	V_{CC}	V_I
t_{PLH}/t_{PHL}	< 2.7V	V_{CC}
	2.7–3.6V	2.7V

Figure 4. Load circuitry for switching times.

8–input multiplexer (3–State)

74LV251

DIP16: plastic dual in-line package; 16 leads (300 mil)   SOT38-4

DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A$_1$ min.	A$_2$ max.	b	b$_1$	b$_2$	c	D$^{(1)}$	E$^{(1)}$	e	e$_1$	L	M$_E$	M$_H$	w	Z$^{(1)}$ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

Note

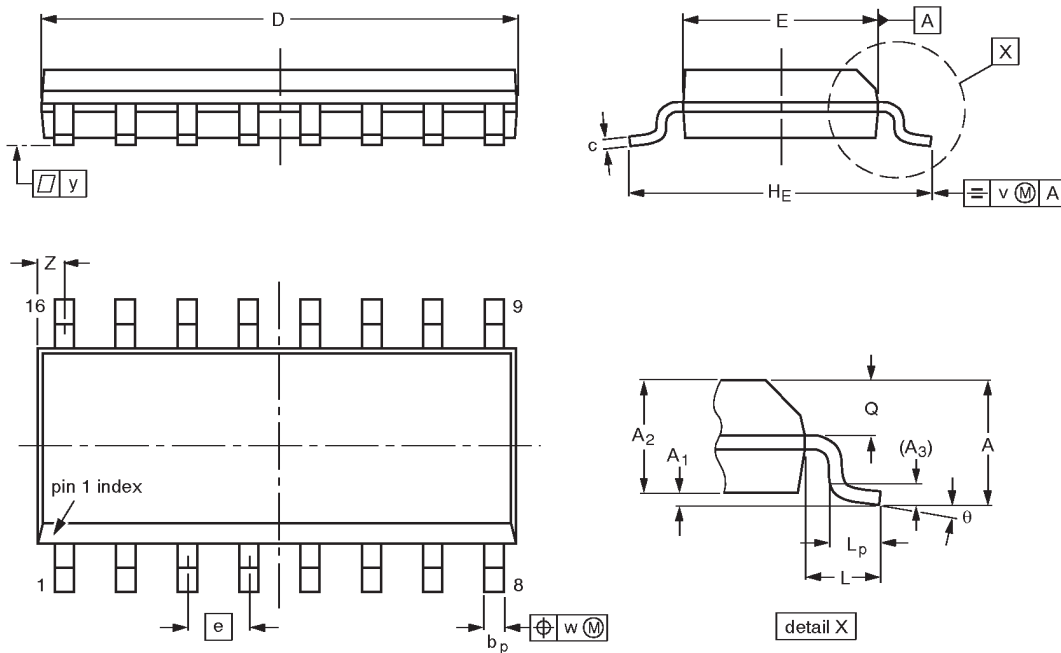1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT38-4						~~92-11-17~~ 95-01-14

8–input multiplexer (3–State)

74LV251

SO16:   plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1


```
0        2.5        5 mm
scale
```

DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.0098 0.0039	0.057 0.049	0.01	0.019 0.014	0.0098 0.0075	0.39 0.38	0.16 0.15	0.050	0.24 0.23	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	

Note

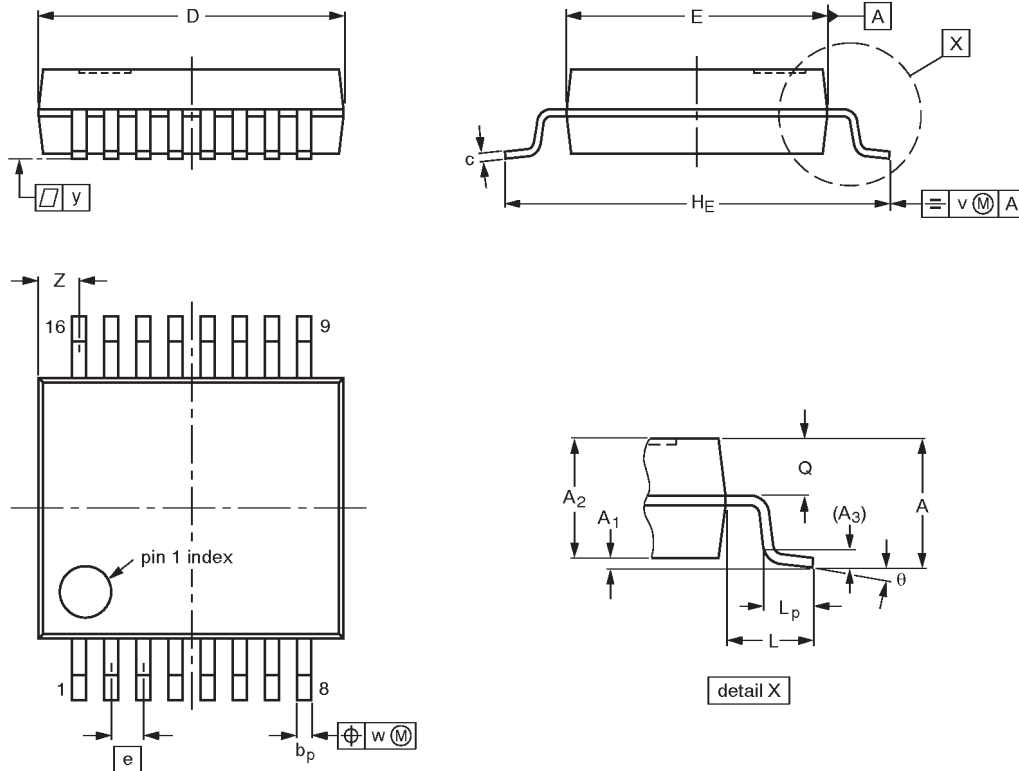1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT109-1	076E07S	MS-012AC				~~91-08-13~~ 95-01-23

8–input multiplexer (3–State)

74LV251

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1

pin 1 index

detail X

0   2.5   5 mm
scale

DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A₁	A₂	A₃	bₚ	c	D [1]	E [1]	e	Hₑ	L	Lₚ	Q	v	w	y	Z [1]	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

Note

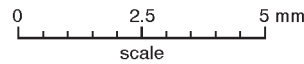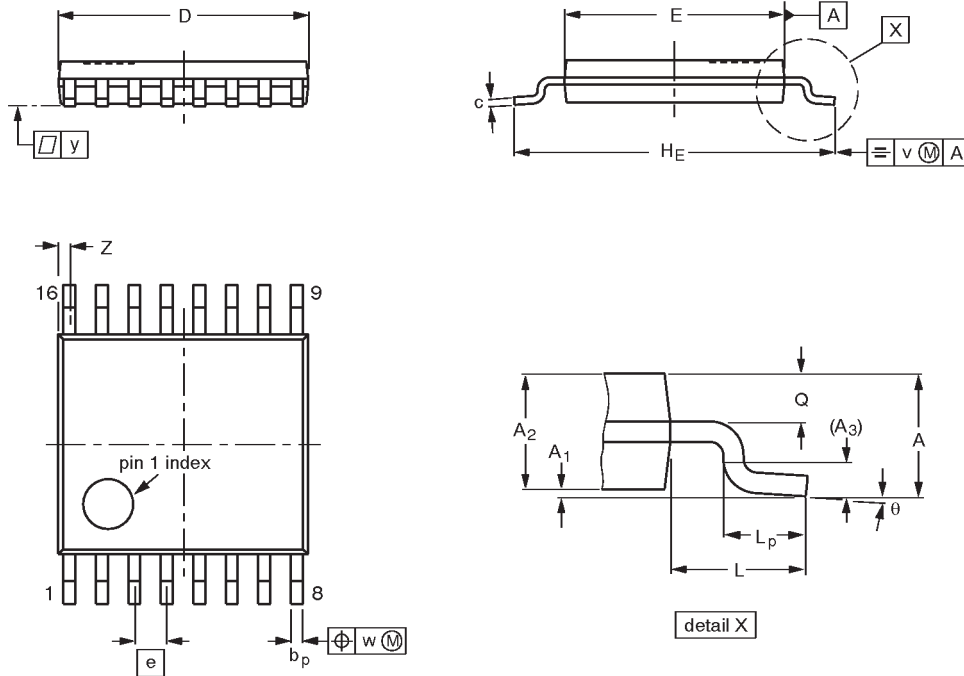1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT338-1		MO-150AC				94-01-14 95-02-04

8–input multiplexer (3–State)

74LV251

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1


```
0        2.5        5 mm
|___|___|___|___|___|
         scale
```

DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A₁	A₂	A₃	bₚ	c	D (1)	E (2)	e	Hₑ	L	Lₚ	Q	v	w	y	Z (1)	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT403-1		MO-153				~~94-07-12~~ 95-04-04

8–input multiplexer (3–State)

74LV251

DEFINITIONS

Data Sheet Identification	Product Status	Definition
Objective Specification	**Formative or in Design**	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.
Preliminary Specification	**Preproduction Product**	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product Specification	**Full Production**	This data sheet contains Final Specifications. Philips Semiconductors reserves the right to make changes at any time without notice, in order to improve design and supply the best possible product.

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